

[Document Name] ABSTRACT

[Title of Invention] ELECTRONIC APPARATUS ENCLOSURE
DEVICE AND ELECTRONIC APPARATUS COOLING SYSTEM

A vapor pipe 103 connects a heat dissipation portion 200 and each
of a plurality of heat receiving portions 102. A liquid pipe 104 connects
the heat dissipation portion 200 and each of a plurality of the heat
5 receiving portions 102. A bypass pipe 105 connects the vapor pipe 103
and the liquid pipe 104. A valve 106 opens and closes a flow path of the
bypass pipe 105. A first connection portion 107 connects the vapor pipe
103 and the bypass pipe 105. A second connection portion 108 connects
the liquid pipe 103 and the bypass pipe 105. The first connection portion
10 107 is disposed at a position higher than that of the second connection
portion 108. As a result, refrigerant can be efficiently transported in a
short time.

[Figure 1.]